Si4176DY

Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static						•	
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		28		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 5.5			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1.2		2.2	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS} -	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1		
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$	10		μΑ		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			Α	
0 0.0 0 0		$V_{GS} = 10 \text{ V}, I_D = 8.3 \text{ A}$		0.016	0.020	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 7.2 \text{ A}$		0.022	0.027		
Forward Transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 8.3 A		23		S	
Dynamic ^b	<u> </u>						
Input Capacitance	C _{iss}			490		pF	
Output Capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		110			
Reverse Transfer Capacitance	C _{rss}			61			
Total Gate Charge	Qg	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 8.3 \text{ A}$		9.6	15	nC	
		30 30		4.7	7.1		
Gate-Source Charge	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 8.3 \text{ A}$		1.65			
Gate-Drain Charge	Q_{gd}			1.75			
Gate Resistance	R_{g}	f = 1 MHz	0.5	2.6	5.2	Ω	
Turn-On Delay Time	t _{d(on)}			15	25	ns	
Rise Time	t _r	V_{DD} = 15 V, R_L = 2.2 Ω		15	25		
Turn-Off Delay Time	t _{d(off)}	$I_D\cong 6.7~A,~V_{GEN}=4.5~V,~R_g=1~\Omega$		13	20		
Fall Time	t _f			10	15		
Turn-On Delay Time	t _{d(on)}			10	15		
Rise Time	t _r	V_{DD} = 15 V, R_L = 2.2 Ω		10	15		
Turn-Off Delay Time	t _{d(off)}	$I_D\cong 6.7~A,~V_{GEN}$ = 10 V, R_g = 1 Ω		15	25		
Fall Time	t _f			10	15		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			4.2	A	
Pulse Diode Forward Current	I _{SM}				40		
Body Diode Voltage	V_{SD}	$I_S = 6.7 \text{ A}, V_{GS} = 0 \text{ V}$		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			15	30	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	L 67 A dl/dt 100 A/ T 05 00		8	16	nC	
Reverse Recovery Fall Time	t _a	$I_F = 6.7 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		8.5		ns	
Reverse Recovery Rise Time	t _b			6.5			

Notes:

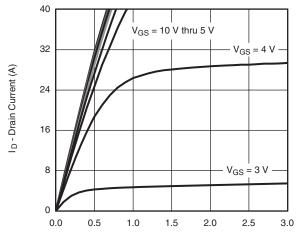
- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



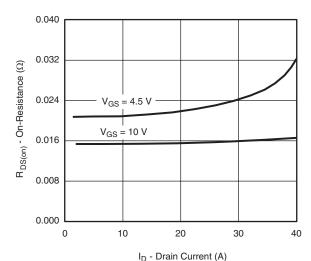
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

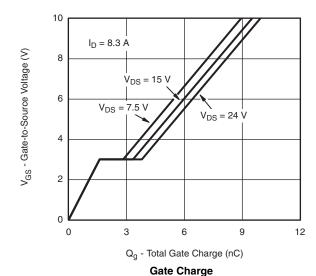


V_{DS} - Drain-to-Source Voltage (V)

Output Characteristics



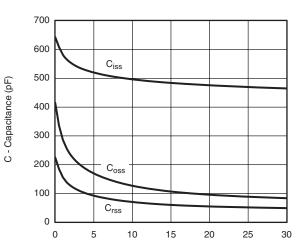
On-Resistance vs. Drain Current



20 16 I_D - Drain Current (A) $T_C = -55$ °C 12 8 $T_{C} = 25$ 4 T_C = 125 °C 0 0.0 0.5 1.0 1.5 2.0 3.0 3.5

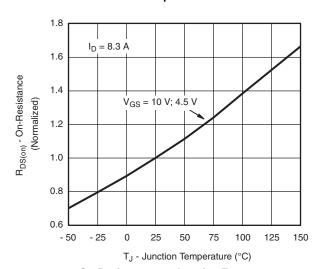
V_{GS} - Gate-to-Source Voltage (V)





V_{DS} - Drain-to-Source Voltage (V)

Capacitance



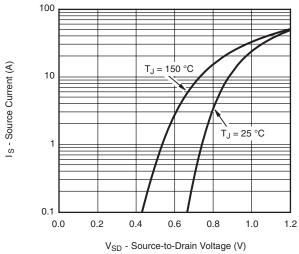
On-Resistance vs. Junction Temperature

Si4176DY

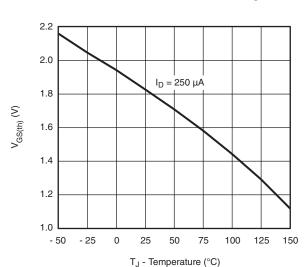
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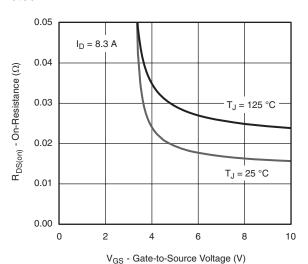
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



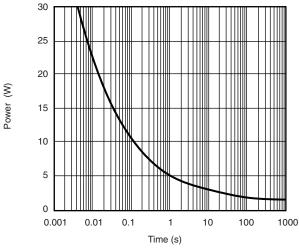
Source-Drain Diode Forward Voltage



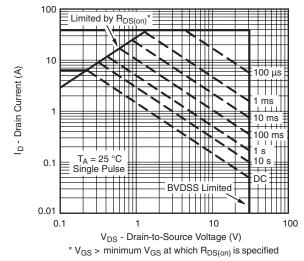
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power

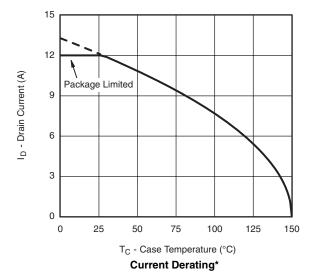


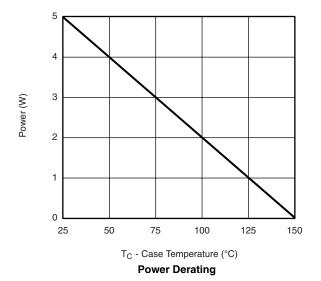
Safe Operating Area, Junction-to-Ambient





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





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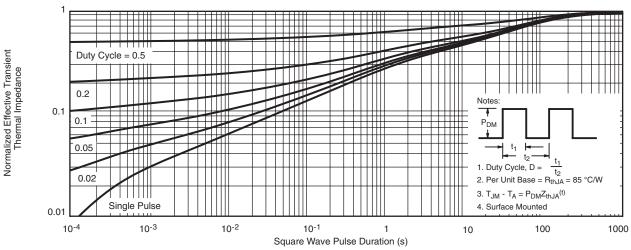
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

Si4176DY

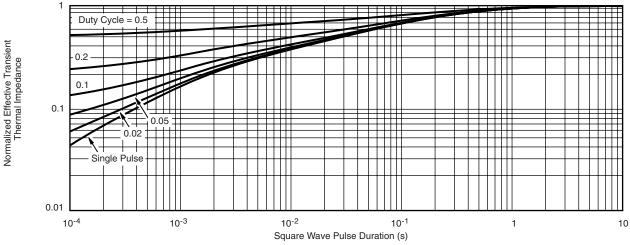
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

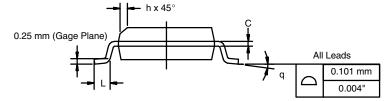
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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES					
DIM	Min	Max	Min	Max				
Α	1.35	1.75	0.053	0.069				
A ₁	0.10	0.20	0.004	0.008				
В	0.35	0.51	0.014	0.020				
С	0.19	0.25	0.0075	0.010				
D	4.80	5.00	0.189	0.196				
E	3.80	4.00	0.150	0.157				
е	1.27	BSC	0.050 BSC					
Н	5.80	6.20	0.228	0.244				
h	0.25	0.50	0.010	0.020				
L	0.50	0.93	0.020	0.037				
q	0°	8°	0°	8°				
S	0.44	0.64	0.018	0.026				
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DWG: 5498

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RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

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